

PolarHT[™] HiPerFET Power MOSFET

N-Channel Enhancement Mode Fast Intrinsic Diode Avalanche Rated

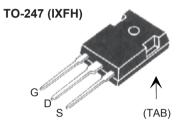
IXFH 110N10P IXFV 110N10P IXFV 110N10PS

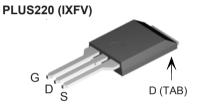


 $V_{DSS} = 100 V$ $I_{D25} = 110 A$ $R_{DS(on)} \le 15 m\Omega$ $t_{max} \le 150 ns$

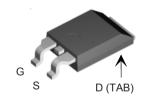
| Symbol | Test Conditions | Maximum | ximum Ratings | |
|--|--|-----------------------------|----------------|--|
| V _{DSS} | T _J = 25° C to 175° C | 100 | V | |
| V _{DGR} | $T_J = 25^{\circ} \text{ C to } 175^{\circ} \text{ C}; R_{GS} = 1 \text{ M}\Omega$ | 100 | V | |
| V _{GSS} | Continuous | ±20 | V | |
| V _{GSM} | Transient | ±30 | V | |
| I _{D25} I _{D(RMS)} I _{DM} | $T_{c} = 25^{\circ} C$ External lead current limit $T_{c} = 25^{\circ} C$, pulse width limited by T_{JM} | 110 75 250 | A A A | |
| I _{AR} | T _C = 25° C | 60 | Α | |
| E _{AR} | T _c = 25° C | 40 | mJ | |
| E _{AS} | T _C = 25° C | 1.0 | J | |
| dv/dt | $I_{S} \leq I_{DM}$, di/dt ≤ 100 A/ μ s, $V_{DD} \leq V_{DSS}$, $T_{J} \leq 150^{\circ}$ C, $R_{G} = 4$ Ω | 10 | V/ns | |
| $\overline{P_{D}}$ | T _c = 25° C | 480 | W | |
| T _J T _{JM} T _{stg} | | -55 +175 175 -55 +150 | °C °C °C | |
| T _L | 1.6 mm (0.062 in.) from case for 10 s Plastic body for 10 s | 300 260 | °C | |
| M _d | Mounting torque (TO-247) | 1.13/10 | Nm/lb.in. | |
| F _c | Mounting Force (PLUS220) | 1165 / 2.515 | N/lb | |
| Weight | TO-247 PLUS220 | 6 4 | g g | |

| - , | Test Conditions unless otherwise specified) | | Ch Min. | _ | istic Va Max | |
|---------------------|---|-------------------------|------------|---|-----------------|--------------------------|
| BV _{DSS} | V_{GS} = 0 V, I_{D} = 250 μA | | 100 | | | V |
| $V_{GS(th)}$ | $V_{DS} = V_{GS}, I_{D} = 4 \text{ mA}$ | | 2.5 | | 5.0 | V |
| GSS | $V_{GS} = \pm 20 V_{DC}, V_{DS} = 0$ | | | | ±100 | nA |
| I _{DSS} | $V_{DS} = V_{DSS}$ $V_{GS} = 0 V$ | T _J = 150° C | | | 25 250 | μ Α μ Α |
| R _{DS(on)} | V_{GS} = 10 V, I_{D} = 0.5 I_{D25} Pulse test, t ≤300 µs, duty (| cycle d ≤ 2 % | | | 15 | mΩ |





PLUS220SMD (IXFV...S)



G = Gate D = Drain S = Source TAB = Drain

Features

- Fast intrinsic diode
- ¹ International standard packages
- Unclamped Inductive Switching (UIS) rated
- ¹ Low package inductance
 - easy to drive and to protect

Advantages

- Easy to mount
- Space savings
- High power density



| Symbo | ol | Test Conditions $(T_J = 25^{\circ} \text{ C})$ | | | ristic Values ise specified) |
|-------------------------------|----|---|------|------|---------------------------------|
| | | | Min. | Тур. | Max. |
| g_{fs} | | V_{DS} = 10 V; I_{D} = 0.5 I_{D25} , pulse test | 30 | 40 | S |
| \mathbf{C}_{iss} |) | | | 3550 | pF |
| C _{oss} | } | $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$ | | 1370 | pF |
| C _{rss} | J | | | 440 | pF |
| $\mathbf{t}_{d(on)}$ |) | | | 21 | ns |
| t _r | | $V_{GS} = 10 \text{ V}, V_{DS} = 0.5 V_{DSS}, I_{D} = 60 \text{ A}$ | | 25 | ns |
| $\mathbf{t}_{d(off)}$ | | $R_{_{G}} = 4 \Omega \text{ (External)}$ | | 65 | ns |
| t _f |) | | | 25 | ns |
| $\mathbf{Q}_{\mathrm{g(on)}}$ |) | | | 110 | nC |
| \mathbf{Q}_{gs} | } | $V_{GS} = 10 \text{ V}, V_{DS} = 0.5 V_{DSS}, I_{D} = 0.5 I_{D25}$ | | 25 | nC |
| \mathbf{Q}_{gd} | J | | | 62 | nC |
| R _{thJC} | | • | | | 0.31° C/W |
| \mathbf{R}_{thCS} | | (TO-247) | | 0.21 | ° C/W |

Source-Drain Diode

Characteristic Values (T₁ = 25°C, unless otherwise specified)

MILLIMETER
MIN MAX
4.30 4.70
0.70 0.90
2.50 3.00
0.00 0.25

1.37 0.70

.433 10.00 11.00

0.90

1.20

1.00

14.00 15.00

13.00 13.70

8.40 8.80 5.08 BSC 5.30 5.80 3.00 3.50

.118

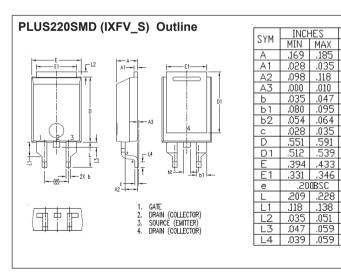
.047

.064

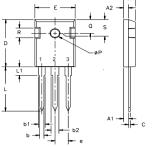
.035 .591 .539

.051

| Symbol | Test Conditions | Min. | Тур. | Max. | |
|--|--|------|------|------|----------|
| I _s | $V_{GS} = 0 V$ | | | 110 | Α |
| I _{SM} | Repetitive | | | 250 | Α |
| V _{SD} | $I_F = I_S$, $V_{GS} = 0$ V, Pulse test, t ≤300 μ s, duty cycle d≤ 2 % | | | 1.5 | V |
| $\left\{ egin{array}{c} \mathbf{t}_{rr} \\ \mathbf{Q}_{RM} \end{array} \right\}$ | $I_F = 25 \text{ A}, -di/dt = 100 \text{ A/}\mu\text{s}$ $V_R = 50 \text{ V}, V_{GS} = 0 \text{ V}$ | | 0.6 | 150 | ns μC |



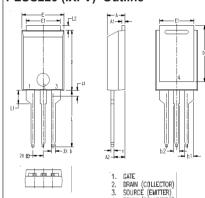
| TO-247 | (IXFH) Outline | |
|--------|---|------|
| D | E O O O O O O O O O O O O O O O O O O O | A2 - |



Terminals: 1 - Gate 2 - Drain 3 - Source TAB - Drain

| Dim. | Millimeter | | Inc | hes |
|----------------|------------|-------|-------|-------|
| | Min. | Max. | Min. | Max. |
| Α | 4.7 | 5.3 | .185 | .209 |
| A ₁ | 2.2 | 2.54 | .087 | .102 |
| A ₂ | 2.2 | 2.6 | .059 | .098 |
| b | 1.0 | 1.4 | .040 | .055 |
| b, | 1.65 | 2.13 | .065 | .084 |
| b ₂ | 2.87 | 3.12 | .113 | .123 |
| С | .4 | .8 | .016 | .031 |
| D | 20.80 | 21.46 | .819 | .845 |
| Е | 15.75 | 16.26 | .610 | .640 |
| е | 5.20 | 5.72 | 0.205 | 0.225 |
| L | 19.81 | 20.32 | .780 | .800 |
| L1 | | 4.50 | | .177 |
| ØP | 3.55 | 3.65 | .140 | .144 |
| Q | 5.89 | 6.40 | 0.232 | 0.252 |
| R | 4.32 | 5.49 | .170 | .216 |
| S | 6.15 | BSC | 242 | BSC |





| CVM | INCHES | | MILLIMETER | |
|-----|---------|------|------------|-------|
| SYM | MIN | MAX | MIN | MAX |
| Α | .169 | .185 | 4.30 | 4.70 |
| A1 | .028 | .035 | 0.70 | 0.90 |
| A2 | .098 | .118 | 2.50 | 3.00 |
| ь | .035 | .047 | 0.90 | 1.20 |
| Ь1 | .080 | .095 | 2.03 | 2.41 |
| b2 | .054 | .064 | 1.37 | 1.63 |
| С | .028 | .035 | 0.70 | 0.90 |
| D | .551 | .591 | 14.00 | 15.00 |
| D1 | .512 | .539 | 13.00 | 13.70 |
| E | .394 | .433 | 10.00 | 11.00 |
| E1 | .331 | .346 | 8.40 | 8.80 |
| е | .100BSC | | 2.54 BSC | |
| L | .512 | .551 | 13.00 | 14.00 |
| L1 | .118 | .138 | 3,00 | 3,50 |
| L2 | .035 | .051 | 0.90 | 1.30 |
| L3 | .047 | .059 | 1.20 | 1.50 |

DRAIN (COLLECTOR)

IXYS reserves the right to change limits, test conditions, and dimensions.



Fig. 1. Output Characteristics

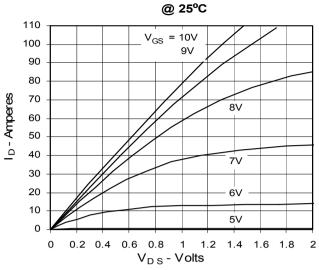


Fig. 3. Output Characteristics @ 150°C

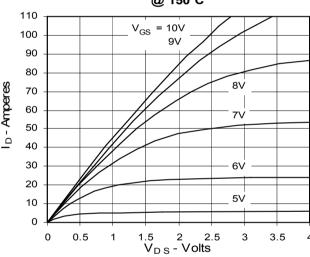


Fig. 5. $R_{\rm DS(on)}$ Normalized to 0.5 $I_{\rm D25}$ Value vs. Drain Current

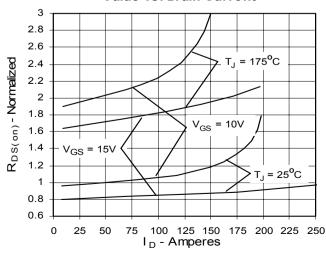


Fig. 2. Extended Output Characteristics @ 25°C

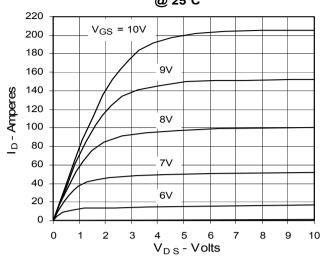


Fig. 4. $R_{DS(on)}$ Normalized to 0.5 I_{D25} Value vs. Junction Temperature

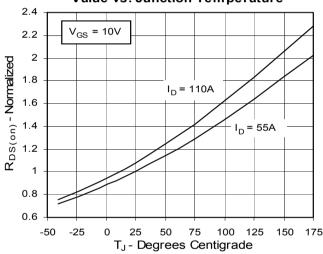
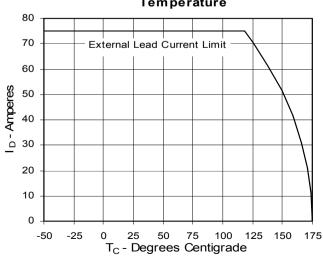


Fig. 6. Drain Current vs. Case Temperature



IXFH 110N10P IXFV110N10P IXFV 110N10PS

Fig. 7. Input Admittance

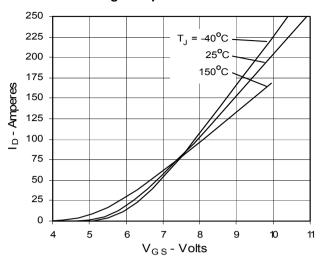


Fig. 8. Transconductance

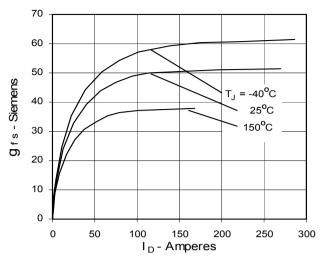


Fig. 9. Source Current vs. Source-To-Drain Voltage

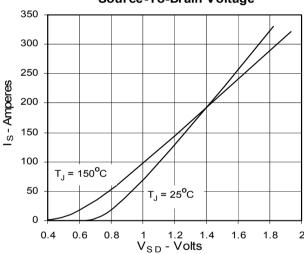


Fig. 10. Gate Charge

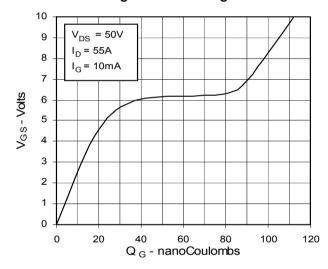


Fig. 11. Capacitance

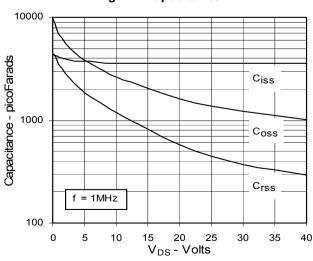
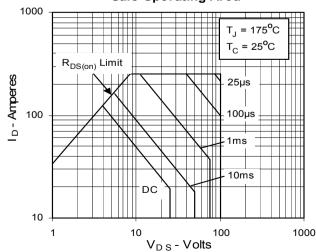


Fig. 12. Forward-Bias Safe Operating Area



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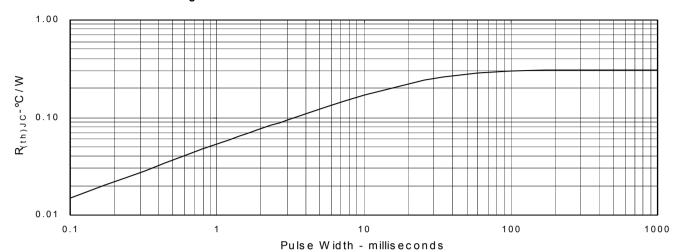


Fig. 13. Maximum Transient Thermal Resistance

